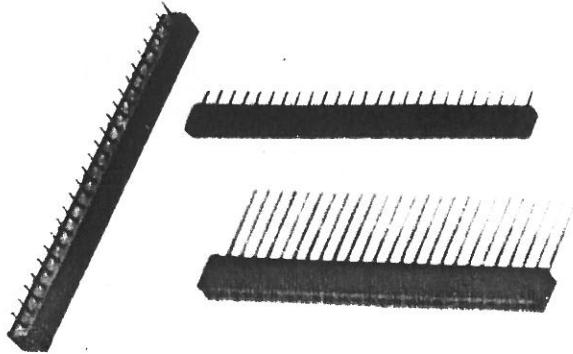
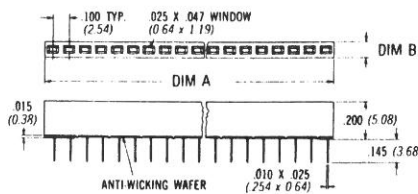


STRIP SOCKETS, SOLDER AND WIRE WRAP*

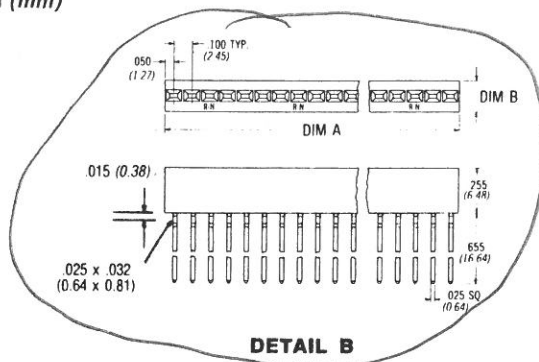


- General Purpose High Reliability Strip Sockets
- Tin/Gold Plating Option Available
- Side and End Stackable in -100 Version
- SBF Series designed to accept flexible jumper strips



DETAIL A

in (mm)



DETAIL B

Part No.	Detail	DIM. A	DIM. B	Body Material	Max. Acc. Pin Size
SB-25-X	A	2.500 (63.5)	.175 (4.44)	Polyester	.015 (.381)
SB-25-100-X	A	2.500 (63.5)	.100 (2.54)	Nylon	.015 (.381)
SBF-25-100-X	A	2.500 (63.5)	.100 (2.54)	Nylon	.025 (.635)
WB-25-55-X	B	2.500 (63.5)	.175 (4.44)	Polyester	.015 (.381)

"X" denotes contact finish; Specify "TG" for tin/gold, "G" for gold, (T) for tin.

(BeCu Contacts available — see pg. 22 "Burn-In Strip Sockets".

WB-9-55-T

MATERIALS: (For applicable Mil Spec see Test Data section.)

BODY: Black polyester, glass-filled, or black nylon, glass-filled (see chart)

CONTACTS: Phosphor bronze, except WB is CA 725

CONTACT FINISH: Suffix TG, for SB-Products and WB-Products
Contact Area: 10 μ inch (.254 μ m) min. gold
over 50 μ inch (1.27 μ m) min. nickel

Terminal Area: 50 μ inch (1.27 μ m) min. electro tin
over 50 μ inch (1.27 μ m) min. nickel

Suffix G, 10 μ inch (0.254 μ m) min. gold
over 50 μ inch (1.27 μ m) min. nickel
on contacts, gold flash on terminals

Suffix T, for SB-Products
30 μ inch (.762 μ m) min. hot
tin dip and wipe

Suffix T, for WB Products
200 μ inch (5.08 μ m) min. tin

RATINGS:

TEMPERATURE RANGE: -65°C to +125°C
FLAMMABILITY: UL 94V-O

MOUNTING INFORMATION:

For SB-Products
PCB HOLE: .035 \pm .002" (0.89 \pm 0.05)
LOCATION: Socket leads are offset .026" (0.66) from IC leads.

For WB-Products
PCB HOLE: .037 \pm .002" (0.94 \pm .05)
LOCATION: Socket leads are offset .018" (0.46) from IC leads.

OTHER MATERIALS: Anti-Wicking Wafer, Nomex 410 (not provided on WB products)

*Trademark of Gardner-Denver Co. Used Throughout Catalog